TERMINATION METAL

INTERCONNECT

SEMICONDUCTOR SUBSTRATE

INTERCONNECT

THERMALLY CONDUCTIVE/MAGNETICALLY PERMEABLE GLUE

THERMALLY CONDUCTIVE/MAGNETICALLY PERMEABLE SUBSTRATE

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FIG. 1

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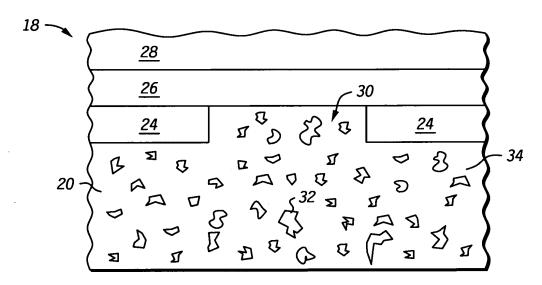


FIG. 2

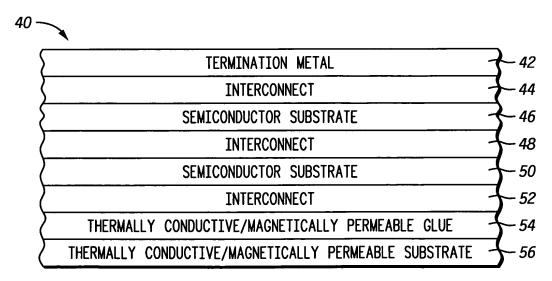


FIG. 3